

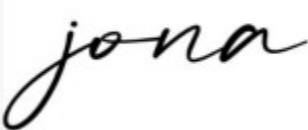


# Shenzhen Leadtek Electronics Co.,Ltd

## PRODUCT SPECIFICATION TFT-LCD MODULE

**Module No: LTK070WSHLM05-V0**

Preliminary Specification

Approval Specification

Designed by	Checked by	Approved by
		

### Final Approval by Customer

Approved by	Comment

※The specification of "TBD" should refer to the measured value of sample . If there is difference between the design specification and measured value, we naturally shall negotiate and agree to solution with customer.

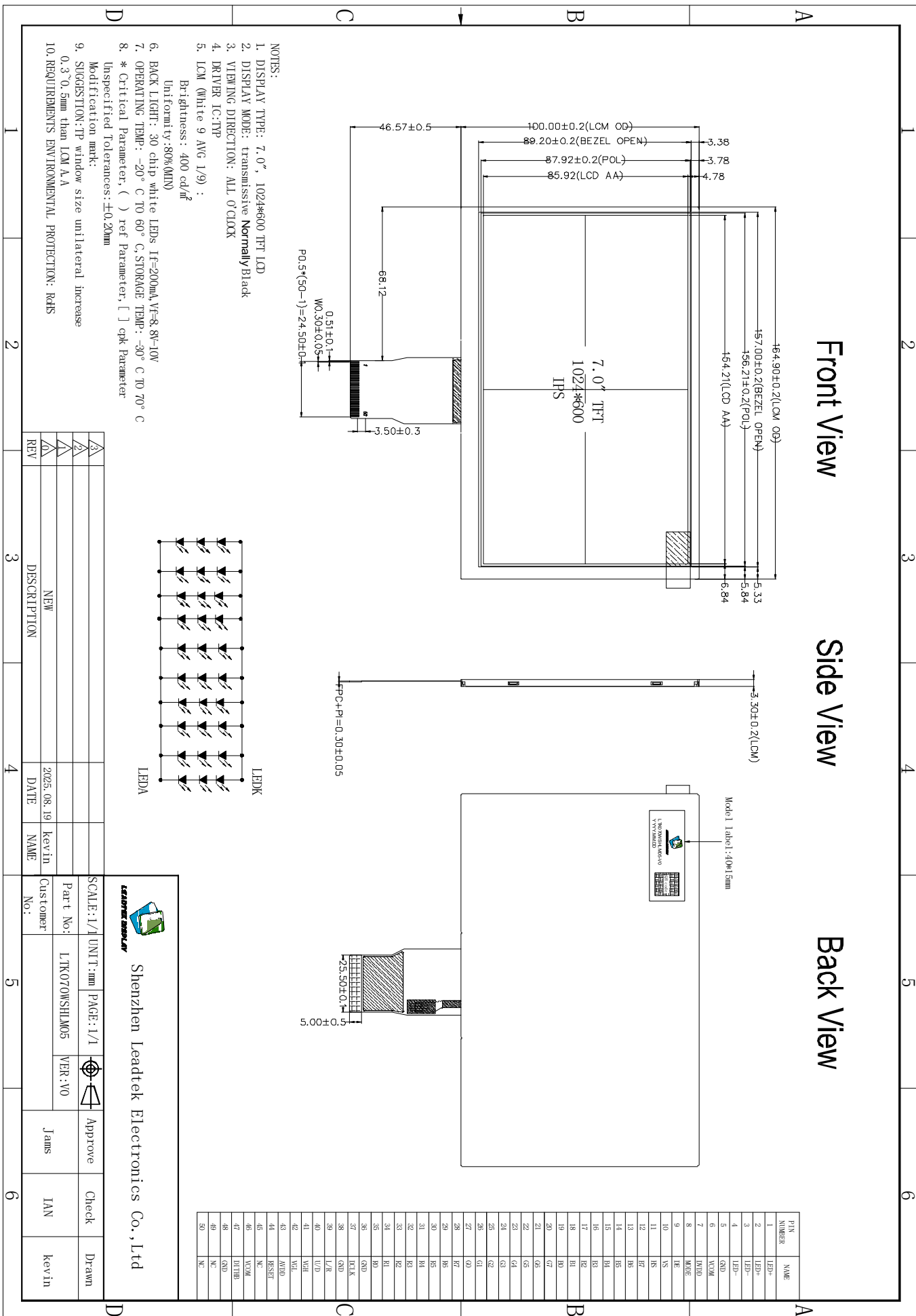


## 2. General Description

NO	Item	Specification	Unit	Remark
1	LCD Size	7.0	inch	-
2	Panel Type	TFT	-	-
4	Resolution	1024 x RGB x600	pixel	-
5	Display Mode	Normally Black	-	-
6	Number of Colors	16.7M	-	-
7	Viewing Direction	ALL	-	-
8	LCM Module Size	164.9 (W) x100(L) x3.3(T)	mm	Note
9	Panel Active Area	154.21 (W) x 85.92(V)	mm	Note
10	Pixel Pitch	0.1505 (H) x 0.1432(V)	mm	-
11	Interface	RGB-24bit	-	-

Note : Please refer to the mechanical drawing;

# 3. Outline Dimension



## 4. Interface Specification

NO.	Symbol	Function	Remark
1	LEDA	POWER SUPPLY- FOR BACKLIGHT CATHODE	
2	LEDA	POWER SUPPLY- FOR BACKLIGHT CATHODE	
3	LEDK	POWER SUPPLY+ FOR BACKLIGHT ANODE	
4	LEDK	POWER SUPPLY+ FOR BACKLIGHT ANODE	
5	GND	Power ground	
6	VCOM	Common voltage	
7	DVDD	Power for Digital Circuit 3.3V	
8	MODE	DE/SYNC mode select. MODE=H:DE mode;MODE=L:SYNC mode	
9	DE	Data enable signal in RGB I/F mode 1	
10	VS	Vertical sync. Signal in RGB I/F	
11	HS	Horizontal sync. Signal in RGB I/F	
12~19	B7~B0	8 bit data bus display blue data	
20~27	G7~G0	8 bit data bus display green data	
28~35	R7~R0	8 bit data bus display red data.	
36	GND	Power ground	
37	DCLK	Pixel clock signal in RGB I/F	
38	GND	Power ground	
39	L/R	Left / right selection	
40	U/D	Up/down selection	
41	VGH	Gate ON Voltage	

42	VGL	Gate OFF Voltage	
43	AVDD	Analog supply voltage.	
44	RESET	Global reser pin	
45	NC	No connection	
46	VCOM	Common Voltage	
47	DITHB	Dithering function. Dithering function. DITHER = H:Enable internal dithering function;	
48	GND	Power ground	
49	NC	No connection	
50	NC	No connection	

## 5. Electrical Characteristics

### 5.1 TFT DC Characteristics

Characteristics	Symbol	Min.	Typ.	Max.	Unit	Note
TFT OperationFrame rate	Hz	--	60	--	Hz	-
Supply Voltage for(DC/DC)	VDD	3.0	3.3	3.6	V	-
TFT Gate ON Voltage	VGH	17	18	19	V	Note 2
TFT Gate OFF Voltage	VGL	-7	-6	-5	V	Note 2
TFT Common Voltage	Vcom	2.3	3.3	4.2	V	Note 1
AVDD	Avdd	9.0	9.6	10.6	V	Note 3

Note 1: VCOM value should be adjusted by different condition to optimize Flicker Value.

Note 2: VGH and VGL are the operating voltages of TFT gate.

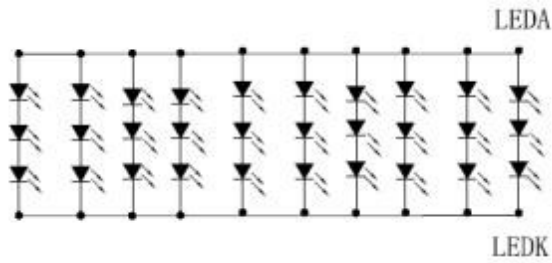
Note 3: Adjust the contrast, make the color bigger and darker, and make the color smaller and lighter.

## 5.2.LED Backlight Specification

Item	Symbol	Min	Typ	Max	Unit	Notes
Forward voltage	Vf	-	9.0	-	V	-
Forward current	IF		200		mA	-
LCM Luminance	Lv		400		cd/m2	-
LED life time	N/A		30,000		Hr	

Note:The “LED life time” is defined as the module brightness decrease to 50% of original brightness at IL=20mA/LED. The LED life time could be decreased if operating IL is larger than 25mA/LED.

### LED circuit:



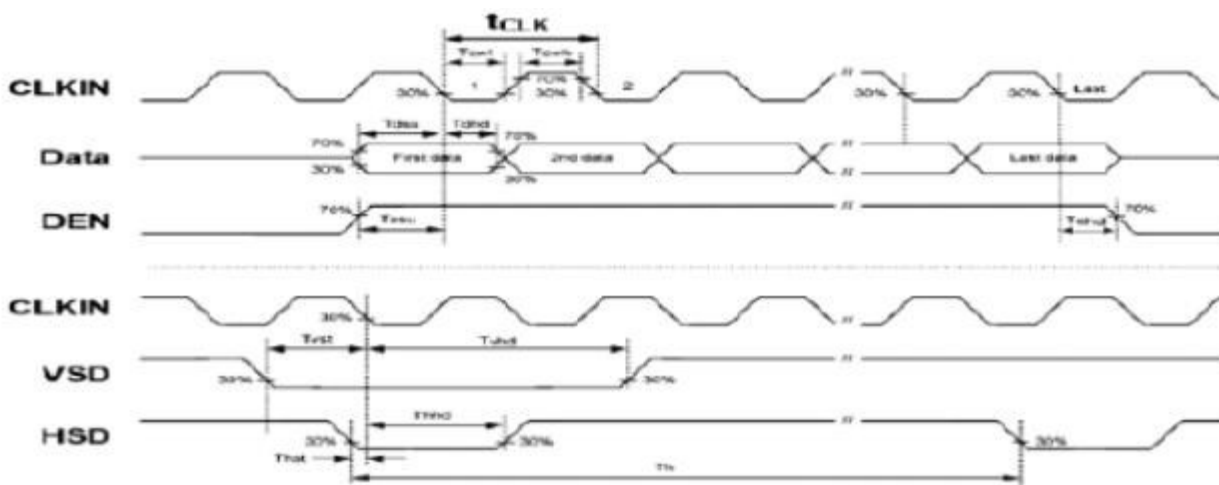
## 6. Timing Characteristics

### 6.1 Input timing table

	ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT	Note
DE MODE	Dot Clock	1/tCLK	45	51.2	57	MHz	
	DCLK Pulse Duty	Tcwh	40	50	60	%	
	Horizontal Total Time	tH	1324	1344	1364	tCLK	
	Horizontal Effective Time	tHA		1024		tCLK	
	Horizontal Blank Time	tHB	300	320	340	tCLK	
	Vertical Total Time	tV	625	635	645	tH	
	Vertical Effective Time	tVA		600		tH	
	Vertical Blank Time	tVB	25	35	45	tH	
SYNC MODE	Horizontal Total Time	TH	1324	1344	1364	tCLK	
	Horizontal Pulse Width	Thpw		20	-	tCLK	t <sub>hb</sub> + t <sub>hpw</sub> = 160DCLK is fixed
	Horizontal Back Porch	Thb		140	-	tCLK	
	Horizontal Front Porch	Thfp	140	160	180	tCLK	
	Horizontal Effective Time	THA		1024		tCLK	
	Vertical Total Time	TV	625	635	645	tH	
	Vertical Pulse Width	Tvpw		3	-	tH	t <sub>vpw</sub> + t <sub>vb</sub> = 23t <sub>H</sub> is fixed
	Vertical Back Porch	Tvb	-	20	-	tH	
	Vertical Front Porch	Tvfp	2	12	22	tH	
Vertical Valid	Tvd		600		tH		

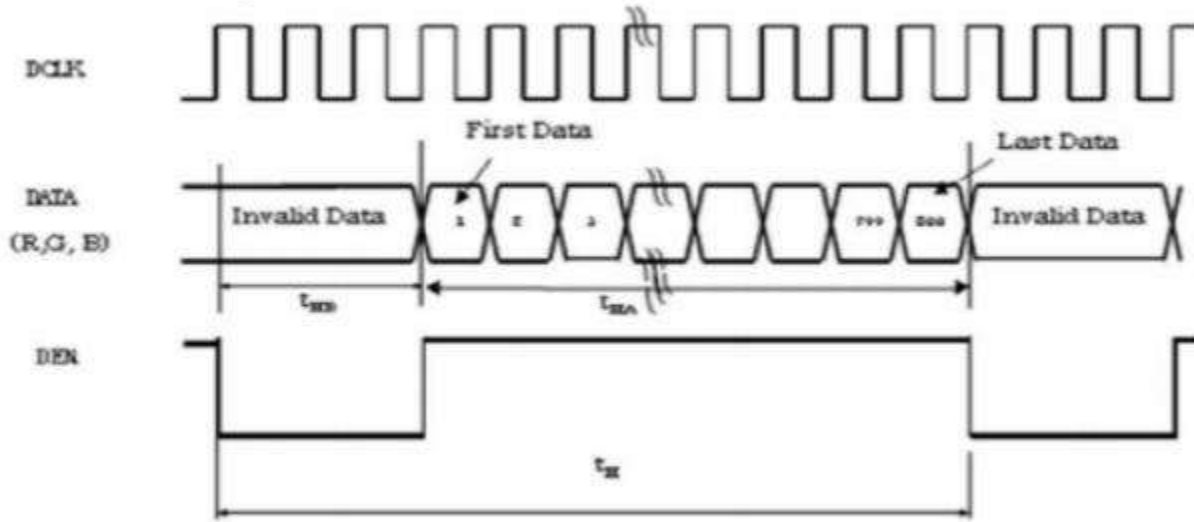
### 6.2 Input clock and data timing diagram

Parameter	Symbol	Spec.			Unit	Condition
		Min.	Typ.	Max.		
DVDD Power On Slew Rate	TPOR	-	-	20	ms	From 0V to 90% DVDD
RSTB Pulse Width	TRst	50	-	-	us	DCLK=65MHz
DCLK Cycle Time	Tcph	14	-	-	ns	
DCLK Pulse Duty	Tcwh	40	50	60	%	
VSD Setup Time	Tvst	5	-	-	ns	
VSD Hold Time	Tvhd	5	-	-	ns	
HSD Setup Time	Thst	5	-	-	ns	
HSD Hold Time	Thhd	5	-	-	ns	
Data Setup Time	Tdsu	5	-	-	ns	D0[7:0], D1[7:0], D2[7:0] to DCLK
Data Hold Time	Tdhd	5	-	-	ns	D0[7:0], D1[7:0], D2[7:0] to DCLK
DEN Setup Time	Tesu	5	-	-	ns	
DEN Hold Time	Tehd	5	-	-	ns	

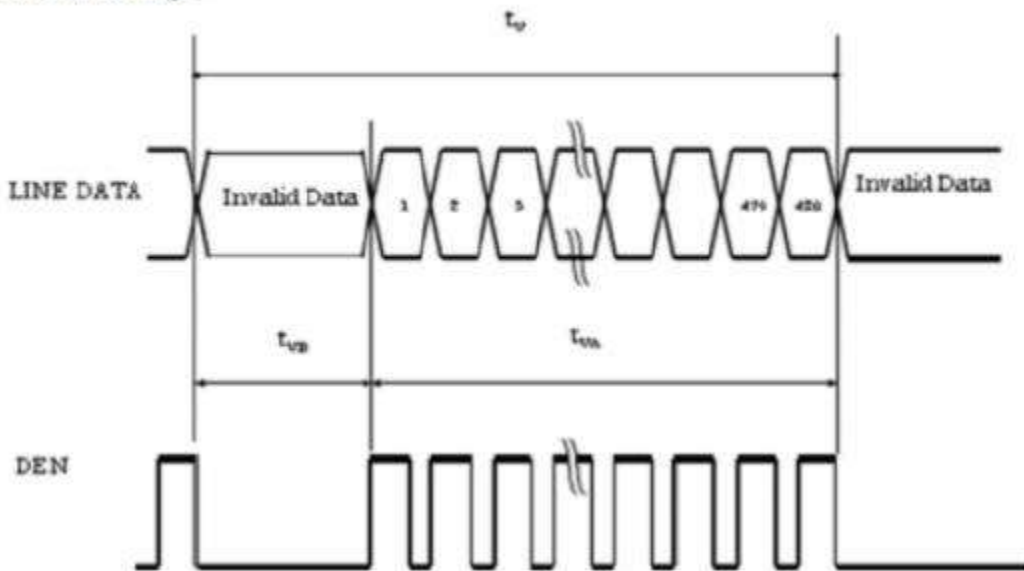


**DE Mode**

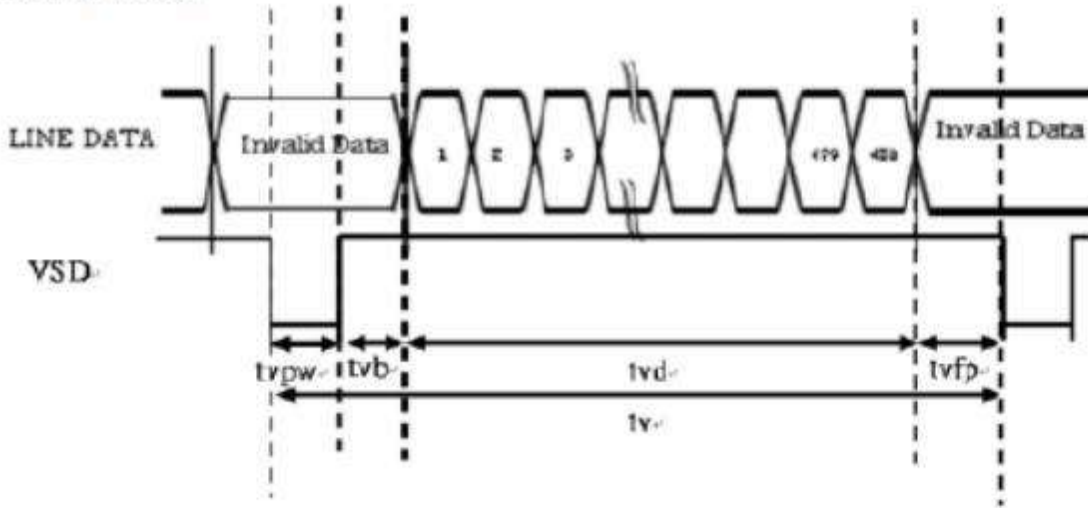
**Horizontal timing :**



**Vertical timing :**

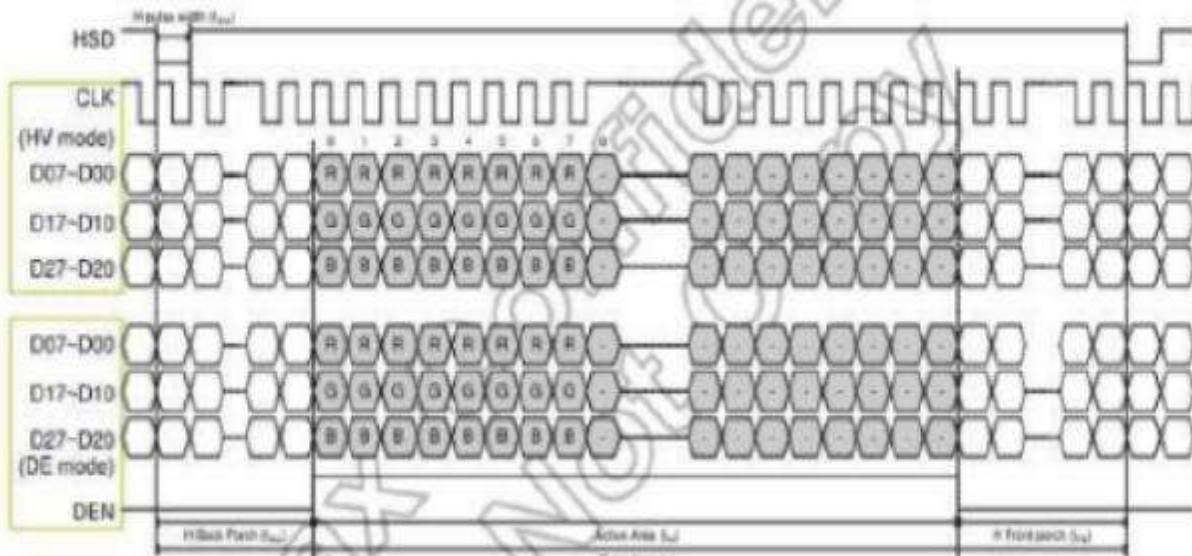


**Vertical timing :**

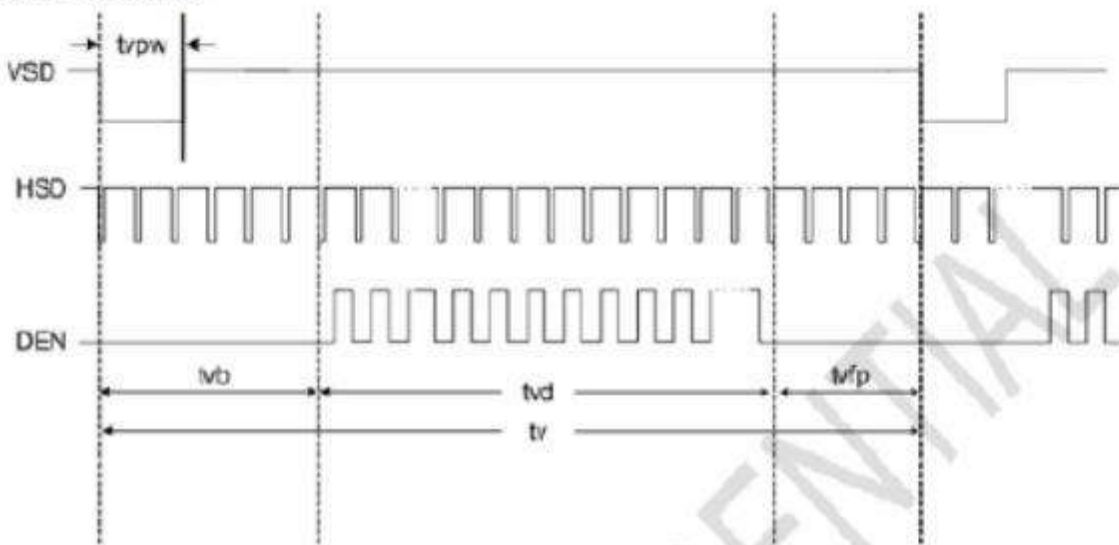


**Data Input Format**

**Horizontal timing :**



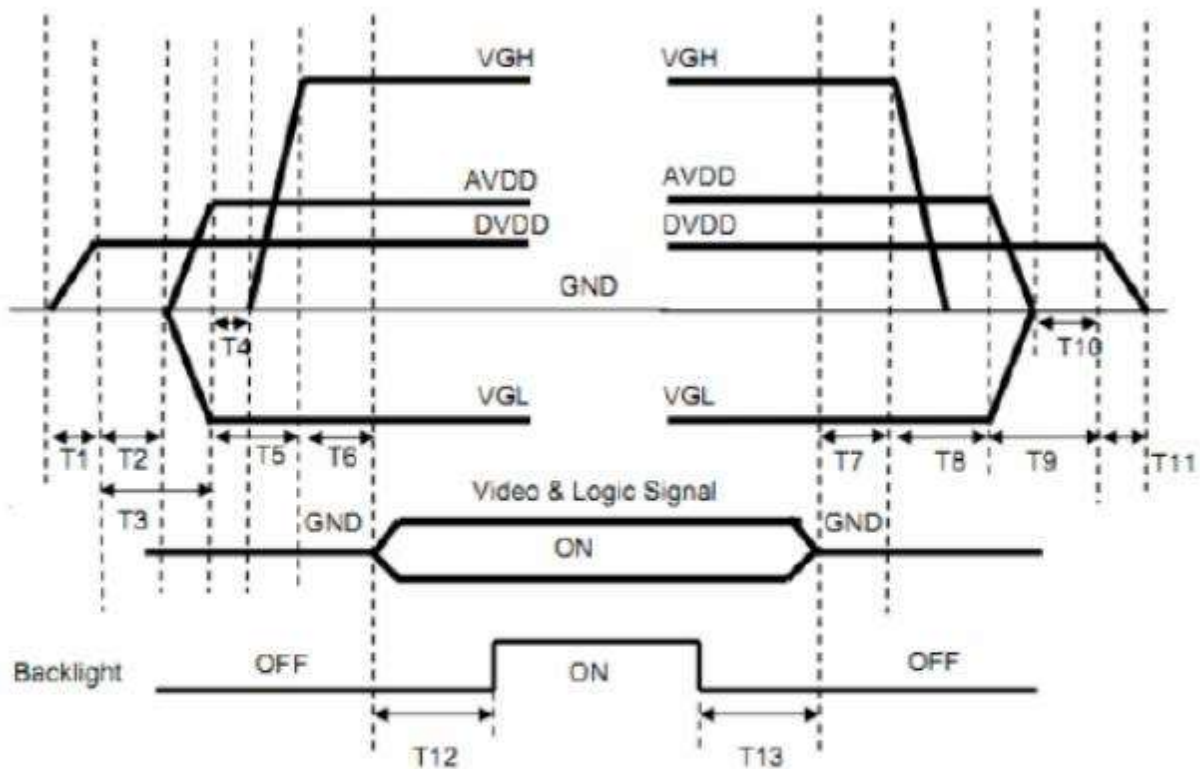
**Vertical timing :**



### 6.3.power signal sequence

#### High speed mode-clock channel timing

Power On : DVDD→AVDD/VGL →VGH →Video & Logic Signal→Backlight  
 Power Off : Backlight→Video & Logic Signal→ VGH→AVDD/VGL→DVDD



$0 < T_1 \leq 10\text{ms}$   
 $T_2 > 0\text{ms}$   
 $T_3 > 20\text{ms}$   
 $T_4 > 0\text{ms}$   
 $T_5 > 10\text{ms}$   
 $0 < T_6 \leq 10\text{ms}$   
 $T_{12} \geq 200\text{ms}$

$T_7 > 0\text{ms}$   
 $T_8 > 0\text{ms}$   
 $T_9 > 0\text{ms}$   
 $T_{10} > 0\text{ms}$   
 $0 < T_{11} \leq 10\text{ms}$   
 $T_{13} \geq 200\text{ms}$

## Reset Input Timing:

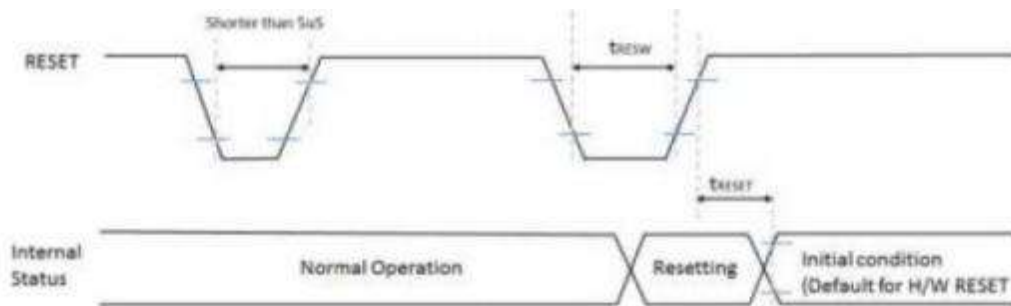


Figure 4-13 Reset Input Timing

Table 4-2 Reset Input Timing

Signal	Symbol	Parameter	Description	Specification			Unit	Notes
				MIN	TYP	MAX		
RESET	tRESW	Reset "L" pulse width		10			µS	1
	tRESET	Reset complete time	When reset applied during Sleep in mode			5	mS	2
			When reset applied during Sleep Out mode			120	mS	5

Note 1: Condition : Ta =25°C

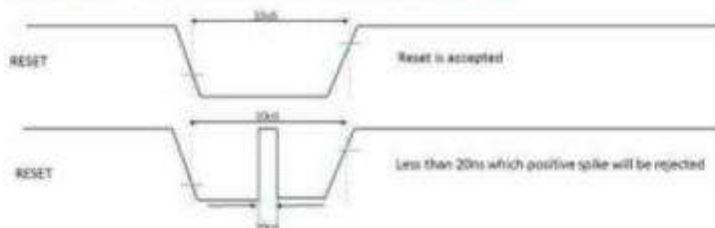
Note 2: Spike due to an electrostatic discharge on RESET line does not cause irregular system reset according to the table below.

RESET Pulse	Action
Less than 5µs	Reset Rejected
More than 10µs	Reset
Between 5µs and 10µs	Reset Start

Note 2: During the resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120ms, when Reset Starts in sleep out mode. The display remains the blank state in sleep in mode) and then return to Default condition for H/W RESET.

Note3: During Reset Complete Time, values in OTP memory will be latched to internal register during this period. This loading is done every time when there is H/W RESET complete time (tRESET) within 5ms after a rising edge of RESET.

Note 4: Spike Rejection also applies during a valid reset pulse as shown below:

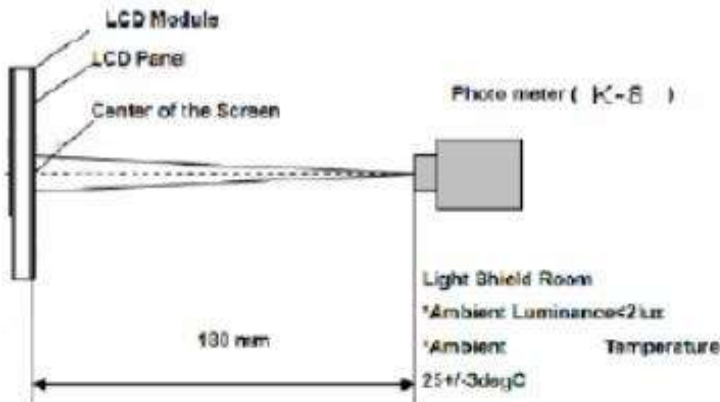


Note 5: It is necessary to wait 5ms after releasing RESET when sending commands, and Sleep Out command can not be sent

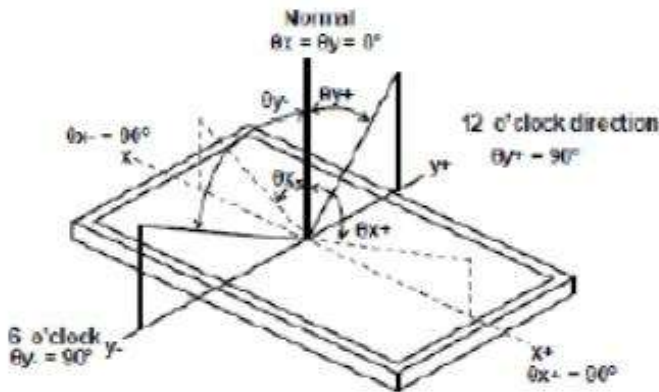
## 7. Optical Specification

Item	Symbol	Condition	Min	Typ	Max	Unit	Remark
Response time	Tr+Tf	$\Theta=0^{\circ}$ $\varnothing=0^{\circ}$ Ta=25°C		25		ms	
Contrast ratio	Cr		600	800			
Color gamut	S (%)		45	50		%	
Luminance uniformity	WHITE		80			%	
Viewing angle range	$\Theta_{x+}$	CR $\geq$ 10 Ta=25°C		85		deg	
	$\Theta_{x-}$			85		deg	
	$\Theta_{y+}$			85		deg	
	$\Theta_{y-}$			85		deg	
CIE(X,Y)Chromaticity	White(X)	$\Theta=0^{\circ}$ $\varnothing=0^{\circ}$ Ta=25°C	0.286	0.306	0.326		
	White(Y)		0.295	0.325	0.355		

Note 1 :Measure condition : $25^{\circ} \pm 2^{\circ} \text{C}$ ,  $60 \pm 100\% \text{RH}$ , under 10 Lux in the dark room. K-8, Viewing angle  $2^{\circ}$  . Measurement after lighting on 10 minus



Note2: Definition of Viewing Angle



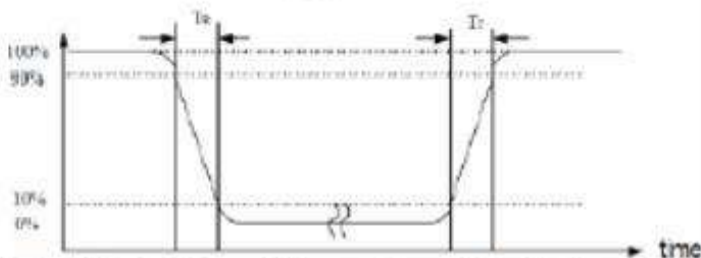
Note3: Definition of contrast ratio:

The contrast ratio can be calculated by the following expression

$$\text{Contrast Ratio (CR)} = L_{255} / L_0$$

L255: Luminance of gray level 255. L0: Luminance of gray level 0

Note4: Definition of response time



Note (5) Definition of Transmittance( Module is without signal input)

$$\text{Transmittance} = \text{Center Luminance of LCD} / \text{Center Luminance of Back Light} \times 100\%$$

## 8. Reliability Test Items

Item	Test Condition	Criterion
High Temperature Operation	60 °C, 48 hrs	Note1 , Note2
Low Temperature Operation	-20 °C, 48 hrs	
High Temperature Storage	70 °C, 48 hrs	
Low Temperature Storage	-30 °C, 48 hrs	
High Temp. & High Humidity Storage	50 °C, 90% RH, 48hrs	
Thermal Shock (Static)	-20°C, 30 min /60°C, 30 min, 2 0 cycles	

Note1: Evaluation should be tested after storage at room temperature for two hours.

Note2:

Pass: Normal display image no line defect.

Fail: No display image, or line defects.

Partial transformation of the module parts should be ignored.

## 9. Precautions

Please pay attentions to the followings as using the LCD module.

### Handling

- (a) Do not apply strong mechanical stress like drop, shock or any force to LCD module. It may cause improper operation, even damage.
- (b) Because the polarizer is very fragile and easy to be damaged, do not hit, press or rub the display surface with hard materials.
- (c) Do not put heavy or hard material on the display surface, and do not stack LCD modules.
- (d) If the display surface is dirty, please wipe the surface softly with cotton swab or clean cloth.

- (e) Avoid using Ketone type materials (e.g. Acetone), Toluene, Ethyl acid or Methyl chloride to clean the display surface. It might damage the touch panel surface permanently. The recommended solvents are water and Isopropyl alcohol.
- (f) Wipe off water droplets or oil immediately.
- (g) Protect the LCD module from ESD. It will damage the LSI and the electronic circuit.
- (h) Do not touch the output pins directly with bare hands.
- (i) Do not disassemble the LCD module.
- (j) Do not lift the FPC of Touch Panel.

### **Storage**

- (a) Do not leave the LCD modules in high temperature, especially in high humidity for a long time.
- (b) Do not expose the LCD modules to sunlight directly.
- (c) The liquid crystal is deteriorated by ultraviolet. Do not leave it in strong ultraviolet ray for a long time.
- (d) Avoid condensation of water. It may cause improper operation.
- (e) Please stack only up to the number stated on carton box for storage and transportation. Excessive weight will cause deformation and damage of carton box.

Operation (a) When mounting or dismantling the LCD modules, turn the power off.

- (b) Protect the LCD modules from electric shock.
- (c) The Driver IC control algorithms stated above should always be obeyed to avoid damaging the LSI and electronic circuit.
- (d) Be careful to avoid mixing up the polarity of power supply for backlight.
- (e) Absolute maximum rating specified above has to be always kept in any case. Exceeding it may cause non-recoverable damage of electronic components or, nevertheless, burning.
- (f) When a static image is displayed for a long time, remnant image is likely to occur.
- (g) Be sure to avoid bending the FPC to an acute shape, it might break FPC.
- (h) Most of the touch screens have air vent to equalize the inside air pressure to the outside one. The air vent must



# 10.Packaging diagram

TBD





# 深圳市丽台电子有限公司

Shenzhen Leadtek Electronics Co.,Ltd

## Incoming Inspection Standard

### 品质允收标准

Model N0. /产品型号: Applicable to Leadtek Touch Display Screen

Updated Date /生效日期: 2025.04.01

Version / 版本号: V0

Record of Revision /修订履历.

Version /版本号	Revision Record /修订内容	Reviser /修订人	Revision Date /修订日期
V0	首发 / Initial release	Green	2025.04.01



## 1、Scope of application /适用范围.

适用于丽台电子触摸显示屏/ Applicable to Leadtek Touch Display Screen.

## 2、Inspection conditions and environment / 检验条件与环境.

### 2.1、Inspection Conditions / 检验条件:

2.1.1、Inspection Distance / 检测距离: 35cm ±5cm.

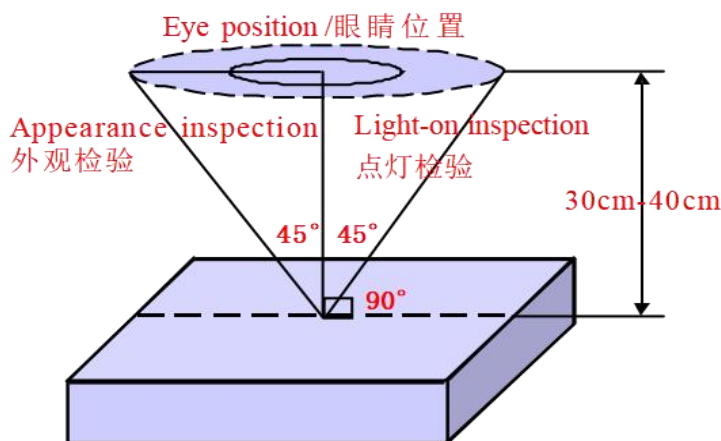
2.1.2、Inspection time /检验时间: Displays performance test /功能测试: 2~3S /Image, Appearance Inspection / 外观检验: 8~10S.

2.1.3、Inspection the viewing angle /检验视角:

Display Inspection Angle /显示检验角度: ±45°.

Appearance Inspection Angle /外观检验角度: ±45°.

Eye position /眼睛位置:



(Perpendicular to LCD panel surface /垂直于LCD表面)

### 2.2、Inspection environment /检验环境:

Temperature / 温度		25±5°C
Humidity / 湿度		55±5%RH
Brightness 亮度	Appearance Inspection / 外观检验	800~1000 Lux
	Display Inspection / 功能检验	200~300 Lux

### 2.3、Sampling conditions / 抽样方式.

Sampling Plan / 抽样计划		GB/T 2828.1- 2003
		Batch single sampling/批量单次抽样
		General inspection level: II/一般检验水平: 二级
AQL	Major Defect / 主要缺陷	0.25
	Minor Defect / 次要缺陷	0.65

### 3、Terms and definitions / 术语和定义.

#### 3.1、Defect classification / 缺陷分类:

3.1.1、Major defects / 主要缺陷: Defects that cause the product to fail or reduce the usability of the product / 引起产品功能失效和减少产品的有效使用与操作的缺陷.

3.1.2、Minor defects / 次要缺陷: Defects that do not affect the functionality and effective use and operation of the product / 不影响产品功能和有效使用与操作的缺陷.

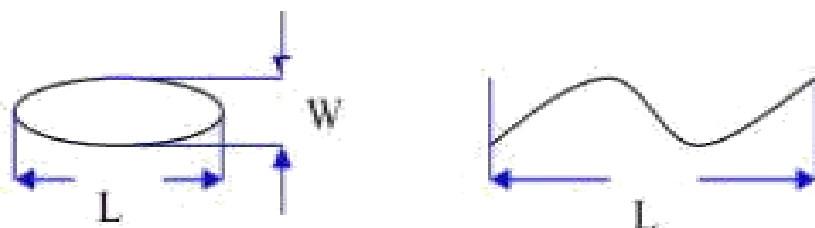
#### 3.2、Point defects / 点状缺陷:

The size of a punctate defect is defined by the diameter D, and the average diameter of the defect is  $D=1/2(W+L)$  / 点状缺陷由直径 D 定义大小, 缺陷的平均直径  $D=1/2(W+L)$ .

#### 3.3、line defects / 线状缺陷:

When defect size  $L \geq 2W$ , the defect count as liner type defect. Size of linear defect is defined by length (L) and the maximum width (W)

当缺陷尺寸  $L \geq 2W$  时, 被视为线状缺陷, 线状缺陷是由长度 (L) 和最大宽度 (W) 定义的.



### 3.4、LCD sub-pixels / LCD 子像素点:

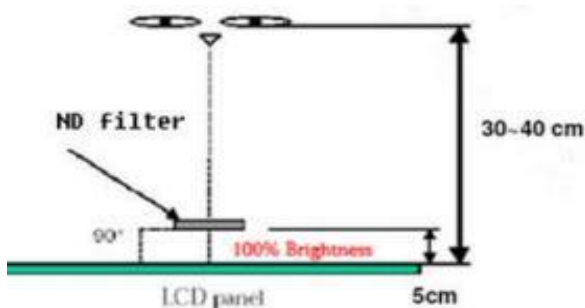
The sub-pixel defect area is greater than 50% of the LCD sub-pixel area, and is visible through ND5% masking

子像素点缺陷面积大于 50% LCD 子像素面积, 且透过 ND5%遮盖是可见的.

### 3.5、ND card test method / ND 卡检验方法:

Hold the ND card about 5cm above the display area, with your eyes 30-40cm away from the panel, and observe for 2~3 seconds

在显示区域上方大约 5cm 处握住 ND 卡, 眼睛距离面板 30-40cm, 观察 2~3 秒.



3.6、Surface substances that can be cleaned are not considered defects (e.g. finger prints on the protective film, dust particles)

可以被清洁干净的表面物质不视为缺陷 (如保护膜上的手指印, 尘粒) .

3.7、Defects that can be covered by the material and are not visible to the eye, and do not affect the function and use are not considered defects

能被物料覆盖目视不可见, 且不影响功能与使用的缺陷不视为缺陷.

3.8、AA shows that damage to the glass outside the area does not affect the effective line and does not expand the loss is acceptable

AA 显示区域以外的玻璃损伤, 不影响有效线路和不会在扩大损失的是可以接受的.

3.9、Issues not specified or defined in this document shall be dealt with through friendly negotiation between the parties / 本文件中未规定或定义的问题, 双方友好协商处理.

## 4.0、Inspection standards /检验标准:

### 4.1、Structural size standards / 结构尺寸标准:

Measurement items /测量项目		Specification /规格	Remark /备注
Name/名称	Unit /单位	Tolerance /公差	
Outside dimension: Length 尺寸: 长	mm /毫米	0.10mm~0.3mm	Please refer to the product specification for detailed dimensions and tolerances 详细的尺寸规格和公差请参考产品规格书
Outside dimension: Width 尺寸: 宽	mm /毫米	0.10mm~0.3mm	
Outside dimension: Thickness 尺寸: 厚	mm /毫米	0.20mm~0.50mm	

### 4.2、Appearance Inspection standards:

( D : diameter, W : width, L : length, N : quantity, DS : spacing )

Material 检验区域	Inspection items 检验项目	Product size 适用尺寸	Inspection standards 检验规格	Category 缺陷类别	
LCD	ITO	Full size 全尺寸	ITO can't open circuit, short circuit, ITO notch cannot exceed 70% of width. ITO 不能有开路 and 短路, ITO 缺口不能超过宽度的70%.	MA	
	Corners broken 崩边/崩角	Full size 全尺寸	1、 It cannot affect the appearance of valid routes and functions; 不能影响有效线路和功能外观.	MA	
			2、 There must be no extensible rips 不能有可延伸性裂纹.	MA	
Silicone 硅胶	Silicone coating 硅胶涂布	Full size 全尺寸	1、 The height cannot exceed the LCD CF surface / 高度不能超过 LCD CF 面.		MI
			2、 No overflow and lack of glue / 不能溢胶和缺胶.		MI
			3、 Silicone cannot cover POL and FPC/ 硅胶不能覆盖到 POL 和 FPC.		MI

Material 检验区域	Inspection items 检验项目	Product size 适用尺寸	Inspection standards 检验规格	Category 缺陷类别	
PCBA FPC Connector 连接器	Appearance 表面外观	Full size 全尺寸	1.FPC is not allowed to have drape/bubble/fold / 不允许有披锋/气泡/褶皱.		MI
			2.Surface scratches do not allow copper leakage / 表面划伤不允许出现漏铜.	MA	
			3.Cracking is not allowed / 不允许破裂.	MA	
			4.Gold finger oxidation is not allowed 不允许金手指氧化.	MA	
			5.Chromatic aberration is not allowed 不允许出现色差.	MA	
	Components 元器件	Full size 全尺寸	1. Damage, missing parts, and incorrect models are not allowed 不允许损伤、缺件、型号错误.	MA	
			2.Components need to be insulated with high temperature adhesive (unless not required by the drawings) / 元器件需要有高温胶绝缘保护 (除非图纸无要求) .		MI
			3.The pads need to be glued with high temperature (unless not required by the drawings) / 焊盘需贴高温胶 (除非图纸无要求) .		MI
	Weld 焊接	Full size 全尺寸	1. False soldering, virtual soldering, and tinning are not allowed 不允许假焊、虚焊、连锡.	MA	
			2. No solder bead residue is allowed 不允许有锡珠残留.		MI
3.The pads need to be glued with high temperature (unless not required by the drawings) / 焊盘需贴高温胶 (除非图纸无要求) .				MI	
POL 偏光片	Scratches 划伤	Under 6 inches 6寸以下	1.W≤0.05mm; L≤5mm, Ignore (忽略) . 2.0.05mm < W≤0.10mm ; L≤5mm ; N≤2; DS≥10mm. 3.0.10mm < W; 5mm < L, Not allowable (不允许) .		MI
		6~10.0 inches 6寸~10.0寸	1.W≤0.07mm; L≤5mm, Ignore (忽略) . 2.0.07mm < W≤0.12mm ; L≤10mm ; N≤3 ; DS≥10mm. 3.0.12mm < W; 10mm < L, Not allowable (不允许) .		MI
		More than 10 inches 10寸以上	1.W≤0.10mm; L≤5mm, Ignore (忽略) . 2.0.10mm < W≤0.15mm ; L≤10mm ; N≤4 ; DS≥10mm. 3.0.15mm < W; 10mm < L, Not allowable (不允许) .		MI

Material 检验区域	Inspection items 检验项目	Product size 适用尺寸	Inspection standards 检验规格	Category 缺陷类别	
POL 偏光片	Bubbles	Under 6 inches 6寸以下	1.D≤0.15mm, Ignore (忽略) . 2.0.15mm < D≤0.30mm; N≤2; DS≥10mm. 3.D > 0.30mm, Not allowable (不允许) .		MI
		More than 6 inches 6寸以上	1.D≤0.20mm, Ignore (忽略) . 2.0.20mm < D≤0.40mm; N≤3; DS≥10mm. 3.D > 0.40mm, Not allowable (不允许) .		MI
	Bubbles around the edges 边缘气泡	Full size 全尺寸	1.Within 1/2BM of the display area, it is not allowed 显示区往外 1/2BM 区域内, 不允许. 2.The display area is 1/2 outside the BM area, and it is not controlled 显示区往外 1/2BM 区域以外, 不管控.		MI
	Point defects Embossing	Under 6 inches 6寸以下	1.D≤0.15mm, Ignore (忽略) . 2.0.15mm < D≤0.30mm; N≤2; DS≥10mm. 3.D > 0.30mm, Not allowable (不允许) .		MI
		6~10.0 inches 6寸~10.0寸	1.D≤0.20mm, Ignore (忽略) . 2.0.20mm < D≤0.40mm; N≤3; DS≥10mm. 3.D > 0.40mm, Not allowable (不允许) .		MI
		More than 10 inches 10寸以上	1.D≤0.25mm, Ignore (忽略) . 2.0.25mm < D≤0.50mm; N≤4; DS≥10mm. 3.D > 0.50mm, Not allowable (不允许) .		MI
	Dirty 脏污	Full size 全尺寸	Dirt, finger prints, etc. are not allowed 不允许有脏污、手指印等.		MI
	Warping 起翘	Full size 全尺寸	Not allowed 不允许.		MI
	Paste offset 贴附偏位	Full size 全尺寸	It is not allowed to exceed the patch tolerance required by the drawing; After TP lamination, it is not allowed to leak the edges of the polarizer 不允许超出图纸要求的贴片公差; 在 TP 贴合后不允许漏偏光片边缘.		MI
	Angle mistake 角度错误	Full size 全尺寸	Not allowed 不允许.		MA
Mixture 混料	Full size 全尺寸	Not allowed 不允许.		MA	

Material 检验区域	Inspection items 检验项目	Product size 适用尺寸	Inspection standards 检验规格	Category 缺陷类别		
TP	Scratches 划伤	Under 6 inches 6寸以下	1.W≤0.05mm; L≤5mm, Ignore (忽略) . 2.0.05mm < W≤0.10mm ; L≤5mm ; N≤2 ; DS≥10mm. 3.0.10mm < W; 5mm < L, Not allowable (不允许) . 4.There is a feeling scratch, Not allowable 有感划伤, 不允许.		MI	
		6~10.0 inches 6寸~10.0寸	1.W≤0.07mm; L≤5mm, Ignore (忽略) . 2.0.07mm < W≤0.12mm ; L≤10mm ; N≤3 ; DS≥10mm. 3.0.12mm < W; 10mm < L, Not allowable (不允许) . 4.There is a feeling scratch, Not allowable 有感划伤, 不允许.		MI	
		More than 10 inches 10寸以上	1.W≤0.10mm; L≤5mm, Ignore (忽略) . 2.0.10mm < W≤0.15mm ; L≤10mm ; N≤4 ; DS≥10mm. 3.0.15mm < W; 10mm < L, Not allowable (不允许) . 4.There is a feeling scratch, Not allowable 有感划伤, 不允许.		MI	
	Black dots white dots 黑点/白点	Under 6 inches 6寸以下	1.D≤0.15mm, Ignore (忽略) . 2.0.15mm < D≤0.30mm; N≤2; DS≥10mm. 3.D > 0.30mm, Not allowable (不允许) .			MI
		6~10.0 inches 6寸~10.0寸	1.D≤0.20mm, Ignore (忽略) . 2.0.20mm < D≤0.40mm; N≤3; DS≥10mm. 3.D > 0.40mm, Not allowable (不允许) .			MI
		More than 10 inches 10寸以上	1.D≤0.25mm, Ignore (忽略) . 2.0.25mm < D≤0.50mm; N≤4; DS≥10mm. 3.D > 0.50mm, Not allowable (不允许) .			MI
	OCA Bubbles 气泡	Full size 全尺寸	Not allowed 不允许.			MI
	Corners broken 崩边/崩角	Full size 全尺寸	1.Product front /产品正面: Edge and corner chipping is not allowed / 崩角、崩边不允许 2.Product back /产品背面: X≤0.5, Y≤0.5, Z≤1/2T; N≤4; DS≥10mm.		MA	
	Silk screen 丝印	Full size 全尺寸	The silk screen is clear, complete and correct 丝印清晰、完整、内容正确.			MI

Material 检验区域	Inspection items 检验项目	Product size 适用尺寸	Inspection standards 检验规格	Category 缺陷类别
TP	Dirty 脏污	Full size 全尺寸	Uncleanable dirt, Not allowable. 不可擦拭的脏污, 不允许.	MI
	Broken 破损	Full size 全尺寸	Not allowable. 不允许.	MI
	Ink color aberration 油墨色差	Full size 全尺寸	$\Delta E > 1$ , Not allowable (不允许).	MI
	Cover pinholes 针孔	Full size 全尺寸	1.D $\leq$ 0.20mm, N $\leq$ 2, DS $\geq$ 10mm, allowable 2.D > 0.20mm, intensive pinholes (密集型针孔), Not allowable (不允许).	MI
	Paint off 掉漆	Full size 全尺寸	Touch-up on the back of the cover is allowed, and the touch-up area cannot exceed 2.0mm in diameter / 允许在盖板背面补漆, 补漆面积不 能超过直径 2.0mm.	MI
BL 背光	Backlight separation 背光分离	Full size 全尺寸	Not allowable 不允许.	MI
	Deformed 变形	Full size 全尺寸	Measured using a plug gauge, If the deformation exceeds 0.3mm, NG is judged 使用塞规测量, 形变超过 0.3mm, 判定 NG.	MI
	Iron frame Oxidation /abscission 铁框氧化/脱落	Full size 全尺寸	Not allowable 不允许.	MI
	Dirt/adhesive residue/solder beads 脏污/残胶/锡珠	Full size 全尺寸	Not allowable 不允许.	MI
	Inkjet/barcode/ QR code 喷码/条码/二维 码	Full size 全尺寸	The inkjet code is clear and complete, the barcode and QR code can be scanned normally, and the content and format meet the requirement / 喷码清晰完整、条码和二维码 可正常扫描, 内容和格式与要求相符.	MI
	Auxiliary materials 辅料	Full size 全尺寸	Accessories (vinyl, double-sided tape, insulating glue, etc.) are not allowed to be missed, misguided, defective, etc 辅料(黑胶、双面胶、绝缘胶等)不允许有漏贴、 贴偏、残缺等.	MI

### 4.3、Functional inspection standards:

( D : diameter, W : width, L : length, N : quantity, DS : spacing )

Material 检验区域	Inspection items 检验项目	Product size 适用尺寸	Inspection standards 检验规格	Category 缺陷类别	
Display Screen 模组	Light leakage / Mura 漏光/ Mura	Full size 全尺寸	1.Use ND5% filter masking, visual invisibility is OK 使用 ND5%遮盖, 目视不可见即为 OK. 2.If necessary, sign off on the sample 必要时, 签限定样.		MI
	Brightness uniformity 亮度均匀性	Full size 全尺寸	Brightness uniformity < 85.0%, Not allowable 亮度均匀性 < 85.0%, 不允许.	MA	
	LCD bright spots/dark spots 玻璃亮点/暗点	Under 6 inches 6寸以下	1.D≤0.10mm, Ignore (忽略) . 2.0.10mm < D≤0.20mm; N≤2; DS≥10mm. 3.D > 0.20mm, Not allowable (不允许) .		MI
		6~10.0 inches 6寸~10.0寸	1.D≤0.15mm, Ignore (忽略) . 2.0.15mm < D≤0.30mm; N≤3; DS≥10mm. 3.D > 0.30mm, Not allowable (不允许) .		MI
		More than 10 inches 10寸以上	1.D≤0.20mm, Ignore (忽略) . 2.0.20mm < D≤0.40mm; N≤4; DS≥10mm. 3.D > 0.40mm, Not allowable (不允许) .		MI
	Backlight black dots/white dots 背光黑点/白点	Under 6 inches 6寸以下	1.D≤0.15mm, Ignore (忽略) . 2.0.15mm < D≤0.30mm; N≤2; DS≥10mm. 3.D > 0.30mm, Not allowable (不允许) .		MI
		6~10.0 inches 6寸~10.0寸	1.D≤0.20mm, Ignore (忽略) . 2.0.20mm < D≤0.40mm; N≤3; DS≥10mm. 3.D > 0.40mm, Not allowable (不允许) .		MI
		More than 10 inches 10寸以上	1.D≤0.25mm, Ignore (忽略) . 2.0.25mm < D≤0.50mm; N≤4; DS≥10mm. 3.D > 0.50mm, Not allowable (不允许) .		MI
	Linear foreign bodies 线状异物	Under 6 inches 6寸以下	1.W≤0.05mm; L≤5mm, Ignore (忽略) . 2.0.05mm < W≤0.10mm ; L≤5mm ; N≤2; DS≥10mm. 3.0.10mm < W; 5mm < L, Not allowable (不允许) .		MI
		6~10.0 inches 6寸~10.0寸	1.W≤0.07mm; L≤5mm, Ignore (忽略) . 2.0.07mm < W≤0.12mm ; L≤10mm ; N≤3 ; DS≥10mm. 3.0.12mm < W; 10mm < L, Not allowable (不允许) .		MI
		More than 10 inches 10寸以上	1.W≤0.10mm; L≤5mm, Ignore (忽略) . 2.0.10mm < W≤0.15mm ; L≤10mm ; N≤4 ; DS≥10mm. 3.0.15mm < W; 10mm < L, Not allowable (不允许) .		MI

Material 检验区域	Inspection items 检验项目	Product size 适用尺寸	Inspection standards 检验规格	Category 缺陷类别	
Display Screen 模组	White/Black print 白印/黑印	Full size 全尺寸	Use ND5% filter masking, visual invisibility is OK 使用 ND5%遮盖, 目视不可见即为 OK.		MI
	Interference pattern/Newtonian pattern 干涉纹/牛顿纹	Full size 全尺寸	Not allowable 不允许.		MI
	Membranes displacement 膜材移位	Full size 全尺寸	Not allowable 不允许.		MI
	Color blocks 色斑	Full size 全尺寸	Use ND5% filter masking, visual invisibility is OK /使用 ND5%遮盖, 目视不可见即为 OK.		MI
	Display abnormal 画异	Full size 全尺寸	Not allowable 不允许.	MA	
	No display 无显示	Full size 全尺寸	Not allowable 不允许.	MA	
	Line/Missing Drawing 线条/缺画	Full size 全尺寸	Not allowable 不允许.	MA	
	Splash screen 闪屏	Full size 全尺寸	Not allowable 不允许.	MA	
	LCD grid LCD 网格	Full size 全尺寸	Not allowable 不允许.	MA	
	Afterimage 残影	Full size 全尺寸	Not allowable 不允许.	MA	
	Wrong viewing angle 可视角错误	Full size 全尺寸	Not allowable 不允许.	MA	
TP	No touch 无触摸	Full size 全尺寸	Not allowable 不允许.	MA	
	Touch the jump point 触摸跳点	Full size 全尺寸	Not allowable 不允许.	MA	
	Touch not sensitive 触摸不灵敏	Full size 全尺寸	Not allowable 不允许.	MA	